TOSHIBA PHOTOCOUPLER GaAlAs IRED & PHOTO-IC

TLP715

Isolated Bus Drivers High Speed Line Receivers Microprocessor System Interfaces

The Toshiba TLP715 consists of a GaAlAs light-emitting diode and an integrated high-gain, high-speed photodetector. This unit is a 6-pin SDIP. The TLP715 is 50% smaller than the 8-PIN DIP and meets the reinforced insulation class requirements of international safety standards. Therefore the mounting area can be reduced in equipment requiring safety standard certification.

The detector has a totem pole output stage to provide both source and sink driving. The detector IC has an internal shield that provides a guaranteed common-mode transient immunity of 10 kV / µs.

The TLP715 is buffer logic type. For inverter logic type, the TLP718 is in line-up.

- Buffer logic output (totem pole output)
- Guaranteed performance over temperature : -40 to 100°C
- Power supply voltage : 4.5 to 20 V •
- Input current: IFLH = 3mA (Max)
- Switching time (tpLH / tpHL): 250 ns (Max)
- Common-mode transient immunity : ±10 kV / µs (Min)
- Isolation voltage : 5000 Vrms (Min) •
- UL recognized UL1577, File No.E67349
- c-UL recognized CSA Component Acceptance Service No. 5A, File No.E67349
- Option (D4) TÜV recognized / VDE under application : DIN EN60747-5-2

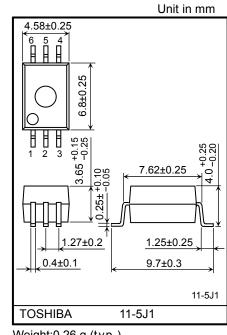
Maximum Operating Insulation Voltage : 890 VPK Highest Permissible Over Voltage : 8000 V_{PK} (Note) : When a EN60747-5-2 approved type is needed, Please designate "Option(D4)"

- Construction Mechanical Rating

	7.62 mm pitch standard type10.16 mm pitch TLPXXXF type			
Creepage Distance	7.0 mm (Min)	8.0 mm (Min)		
Clearance	7.0 mm (Min)	8.0 mm (Min)		
Insulation Thickness	0.4 mm (Min)	0.4 mm (Min)		

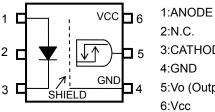
Truth Table

Input	LED	Tr1	Tr2	Output
Н	ON	ON	OFF	Н
L	OFF	OFF	ON	L

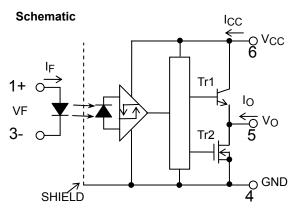


Weight: 0.26 g (typ.)

Pin Configuration (Top View)



3:CATHODE 5:Vo (Output)



0.1 µF bypass capacitor must be connected between pins 6 and 4. (Note 5)

Absolute Maximum Ratings (Ta = 25°C)

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	CHARACTERISTIC	SYMBOL	RATING	UNIT					
	Forward Current (Ta ≤ 83°C)	١ _F	20	mA					
	Forward Current Derating (Ta ≥ 83°C)	ΔI _F /ΔTa	-0.48	mA/°C					
LED	Peak Transient Forward Current (Note 1)		1	А					
	Reverse Voltage	VR	5	V					
	Junction Temperature Output Current 1 (Ta ≤ 25°C)		125	°C					
DETECTOR	Output Current 1 (Ta ≤ 25°C)	^I O1	25 / -15	mA					
	Output Current 2 (Ta ≤ 100°C)		13 / -13	mA					
	Output Voltage		-0.5 to 20	V					
Ë	Supply Voltage		-0.5 to 20	V					
	Junction Temperature	IO1 IO2 13 / -13 VO -0.5 to 20 VCC -0.5 to 20 Tj 125							
Oper	ating Temperature Range	Topr	-40 to 100	°C					
Stora	ge Temperature Range	Tstg	-55 to 125	°C					
Lead	Solder Temperature (10 s)	Tsol	260	°C					
Isola	tion Voltage (AC,1 min., R.H. \leq 60%, Ta = 25°C) (Note 2)	BVs	5000	Vrms					

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

- Note 1: Pulse width PW \leq 1µs, 300pps.
- Note 2: Device Considered a two terminal device : pins 1,2 and 3 shorted together and pins 4,5 and 6 shorted together.

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Input Current, ON	^I F (ON)	4.5	-	10	mA
Input Voltage, OFF	V _{F (OFF)}	0	I	0.8	V
Supply Voltage*	V _{CC}	4.5	-	20	V
Operating Temperature	Т _{орг}	-40	-	100	°C

Recommended Operating Conditions

* This item denotes operating ranges, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Unless otherwise specified, Ta =-40 to 100°C, V_{CC} = 4.5 to 20 V.)

	-	-, -			,		,		
CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION			MIN	TYP. *	MAX	UNIT
Input forward voltage	VF	—	I _F = 5 mA , Ta = 25°C			1.4	1.6	1.7	V
Temperature coefficient of forward voltage	ΔV _F /ΔTa	_	I _F = 5 mA			_	-2.0	_	mV/°C
Input reverse current	۱ _R	—	V _R = 5 V , 1	Га = 2	5°C	_	—	10	μA
Input capacitance	С _Т	_	V = 0 V, f =	1 MH	z, Ta = 25°C	_	45	_	pF
Logic LOW output voltage	V _{OL}	1	I _{OL} = 3.5 m	A, V _F	= 0.8 V	_	0.2	0.6	V
	VOH				V _{CC} = 4.5 V	2.7	3.5	_	
Logic HIGH output voltage	(Note3)	2			V _{CC} = 20 V	17.4	19	_	V
Logic LOW supply current	ICCL	3	V _F = 0V		_	_	3.0	mA	
Logic HIGH supply current	Іссн	4	I _F = 5 mA			_	_	3.0	mA
Logic LOW short circuit	1	-)/ 0)/	Vcc	; = V _O = 5.5 V	15	80		
output current	IOSL	5	V _F = 0V	Vcc	; = V _O = 20 V	20	90	_	mA
Logic HIGH short circuit		IF = 5mA, V _{CC} = 5.5 V	; = 5.5 V	-5	-15	_	m۸		
output current (Note4)	IOSH	6	V _O = GND	VCC	; = 20 V	-10	-20	_	mA
Input current logic LOW output (Note4)	IFLH	_	I _O = -2.6 mA, V _O > 2.4 V		_	0.4	3	mA	
Input voltage logic HIGH output	V _{FHL}	_	I _O = 3.5 mA, V _O < 0.6V		0.8	_	_	V	
Input current hysteresis	IHYS	—	V _{CC} = 5 V			_	0.05	_	mA

* All typical values are at Ta=25°C, V_{CC}=5 V unless otherwise specified

Note 3: $V_{OH} = V_{CC} - V_O [V]$

Note 4: Duration of output short circuit time should not exceed 10 ms.

Note 5: A ceramic capacitor (0.1 µA) should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

Isolation Characteristics (Ta = 25°C)

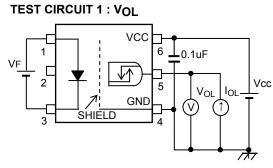
CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance input to output	CS	V = 0 V, f = 1 MHz (Note 2)	_	1.0	_	pF
Isolation resistance	R _S	R.H. ≤ 60%, V _S = 500 V (Note 2)	1×10 ¹²	10 ¹⁴	_	Ω
		AC, 1 minute	5000	_	_	V
Isolation voltage	BVS	AC, 1 second, in oil	-	10000	_	V _{rms}
		DC, 1 minute, in oil		10000	_	Vdc

Switching Characteristics

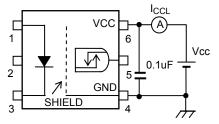
(Unless otherwise specified, Ta = -40 to 100° C, Vcc = 4.5 to 20 V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION	MIN	TYP. *	MAX	UNIT	
Propagation delay time to logic HIGH output	^t pLH		$I_F = 0 \rightarrow 3 \text{ mA}$	30	120	250	ns	
Propagation delay time to logic LOW output	^t pHL		$I_F = 3 \rightarrow 0 \text{ mA}$	30	120	250	ns	
Switching time dispersion between ON and OFF	^t pHL ⁻ ^t pLHl	7,8	_	_		220	ns	
Rise Time (10 – 90 %)	tr			IF = 0 \rightarrow 3 mA, V _{CC} = 5 V	_	30	_	ns
Fall Time (90 – 10 %)	tf		I_{F} = 3 \rightarrow 0 mA, V_{\text{CC}} = 5 V	_	30	_	ns	
Common-mode transient Immunity at HIGH level output	CMH		V _{CM} = 1000 Vp-p, I _F = 5 mA, V _{CC} = 20 V, Ta = 25°C	10000	_	_	V/µs	
Common-mode transient Immunity at LOW level output	CML	9	V _{CM} = 1000 Vp-p, I _F = 0 mA, V _{CC} = 20 V, Ta = 25°C	-10000	_	_	V/µs	

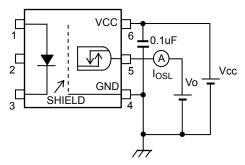
*All typical values are at Ta = 25° C.



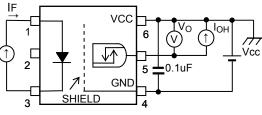
TEST CIRCUIT 3 : ICCL



TEST CIRCUIT 5 : IOSL

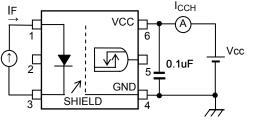




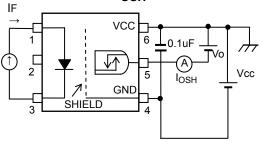


 $\mathsf{V}_{OH}\text{=}\mathsf{V}_{CC}\text{-}\mathsf{V}_{O}\left[\mathsf{V}\right]$

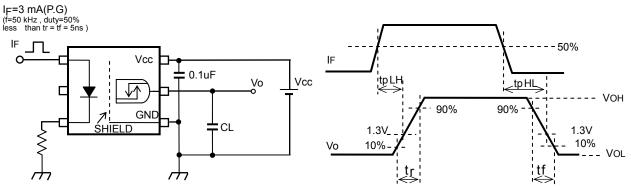
TEST CIRCUIT 4 : ICCH





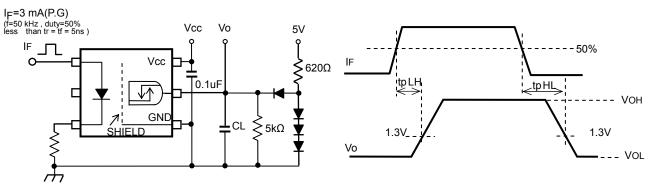


TEST CIRCUIT 7: Switching Time Test Circuit



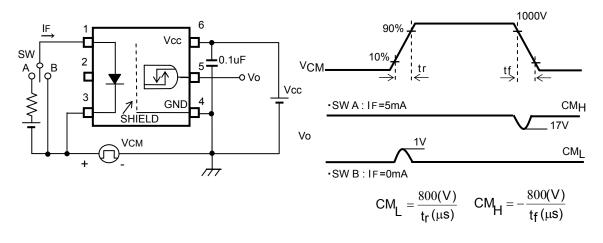
CL: stray capacitance of probe and wiring (to 15 pF)

TEST CIRCUIT 8: Switching Time Test Circuit



CL: stray capacitance of probe and wiring (to 15 pF)

TEST CIRCUIT 9: Common-Mode Transient Immunity Test Circuit



 CM_H (CM_L) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the high (low) state.

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